專題進度報告

NEURAL NETWORK BASED ON CIM WITH FERRO-MATERIAL

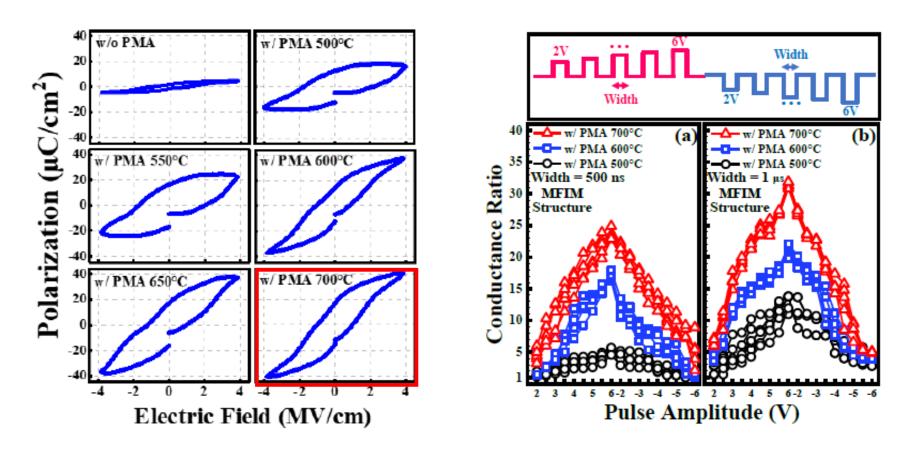
0612020 吳峻陞 0612119 呂宗翰

Structure and Implementation

- a. Ferroelectric Material Characteristic Applications
 - Ferroelectric Tunnelling Junction
 - Ferroelectric FET
- b. Intrinsic Logic Design and Unit Cell (Neuron) Design

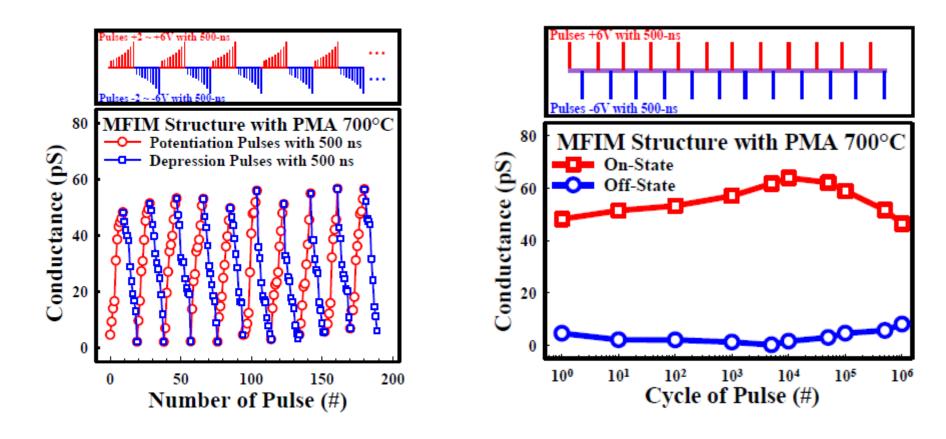
- Ferroelectric Tunnelling Junction

Variation by Temperature



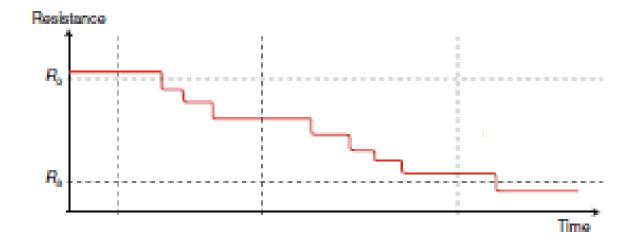
FTJ processed by PMA 700°C has the best window and symmetrical alignment distribution

Binary State of Ferroelectric Material



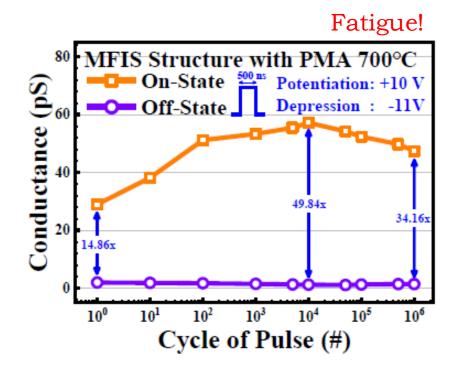
Using Conductance Difference to determine 0-1 state

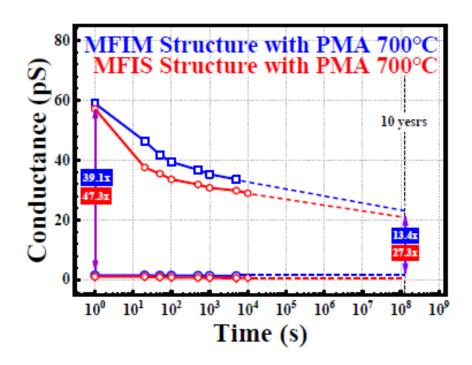
Multi-state Feasibility in long-term pulse exertion



By applying appropriate buffer layer, the step-like resistance change have the possibility to implement multi-state in a single neuron

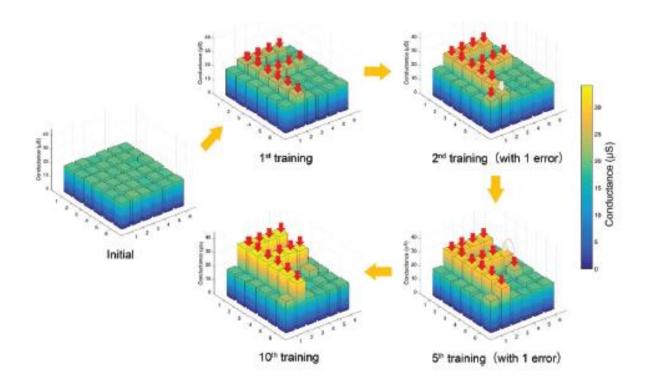
Endurance and Memory Effect after operations





FTJ provides sufficient gap for sensoring

As training interface

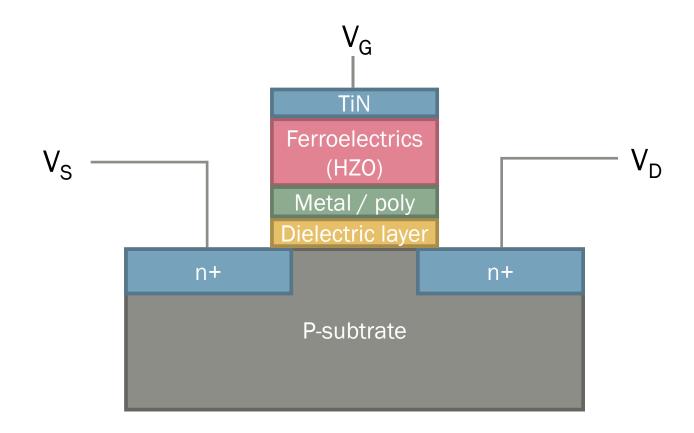


- 1. With repeatedly inputting same training pattern, the increasing conductance can augment the performance as neurons
- 2. Flexibility to assign higher on/off standard to eliminate possible errors

- Structure and Implementation

- Ferroelectric FET

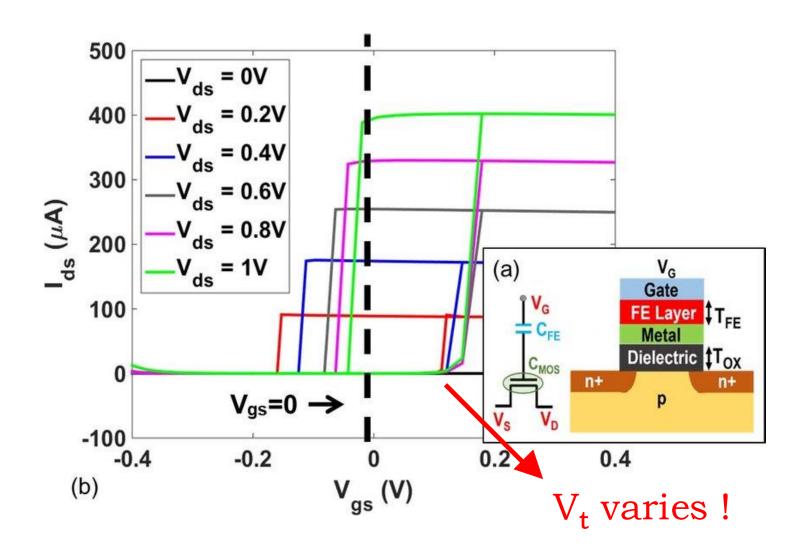
FET with Ferro-Material in Gate



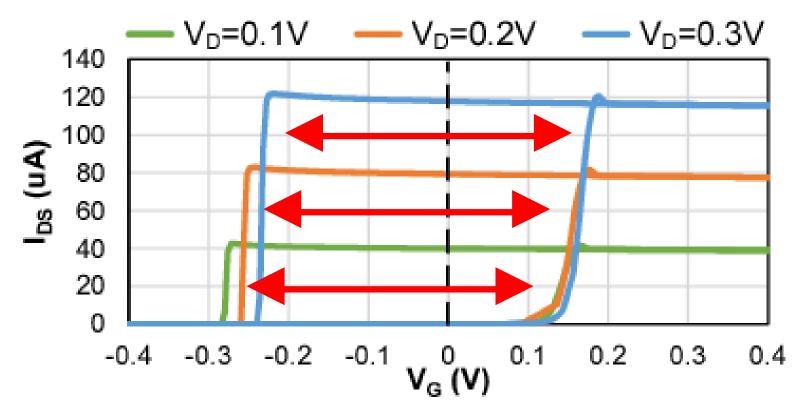
VGS -> Charge and discharge (HRS or LRS)

VDS -> On or Off FeFET

FeFET Characteristics



Method to distinguish states



The states will be distinguished due to different V_t (FET on or off) by employing the same $V_{\rm DS}$

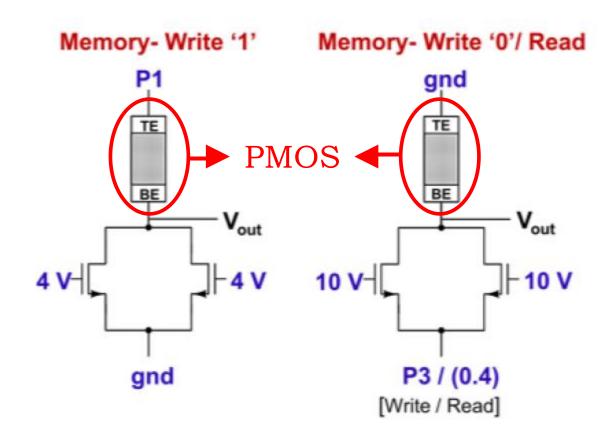
Benefits

- Same memory architecture with common MOS
- Non-Volatile MOS (no leakage current)
- Compatible speed and scalability with MOS nowadays

b. Intrinsic Logic Design and Unit Cell (Neuron) Design

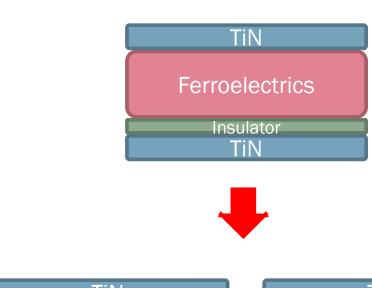
- FTJ

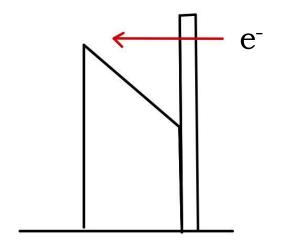
Concept with FTJ

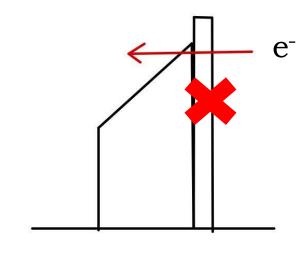


Inspired by this seemingly pseudo circuit, FTJ has potential to be operated like a complementary NMOS

Concept with FTJ



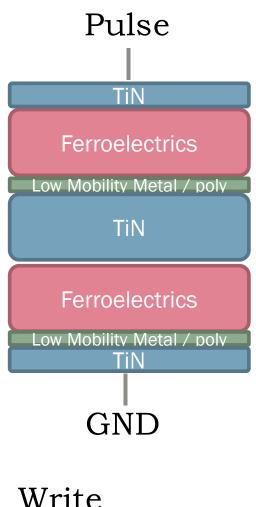




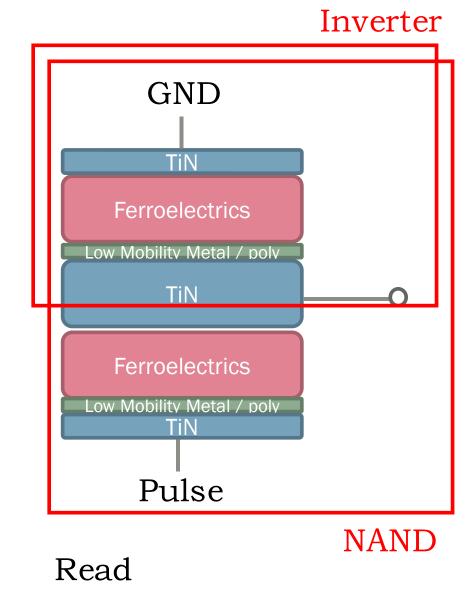
TiN Ferroelectrics TiN TiN
Ferroelectrics
Low Mobility Metal / poly
TiN

To deal with the barrier problem of inverse direction of read and write, I attempt to use loss mobility metal, which has the same effect to release trapped electrons as insulator, or eliminate insulator to perform logics

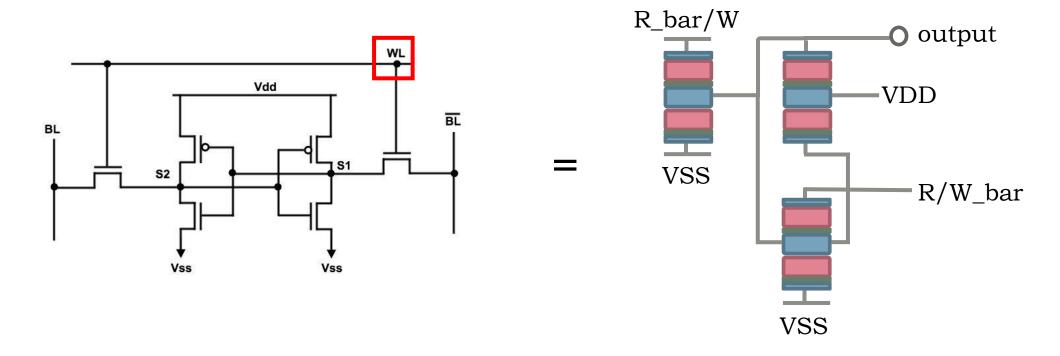
Logics of FTJ



Write



SRAM with FTJ

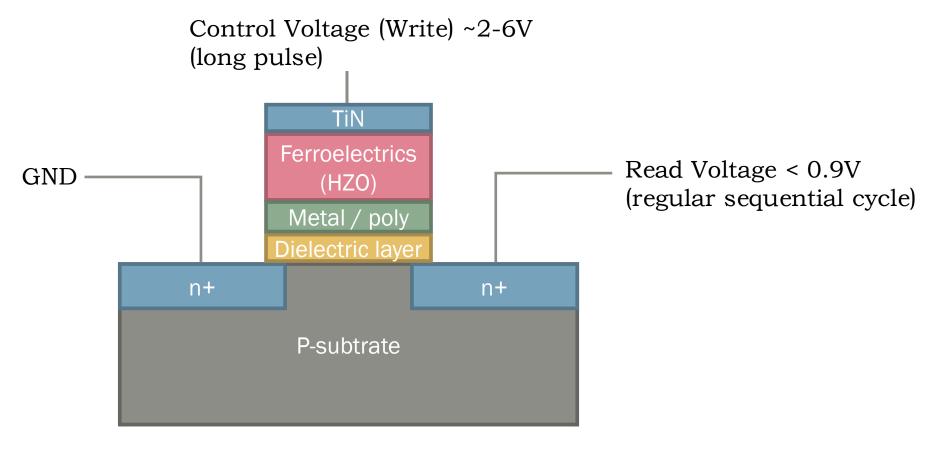


Simulating the structure of SRAM, we can accordingly design FTJ SRAM while inputting write pulse as 6V and read pulse as 0.8V in reverse directions,

b. Intrinsic Logic Design and Unit Cell (Neuron) Design

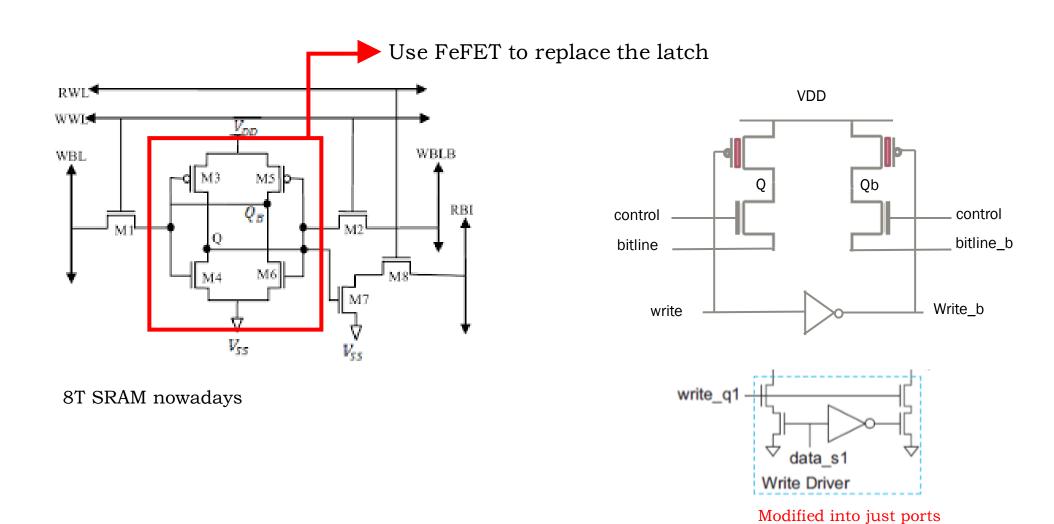
- FeFET

Concept with FeFET

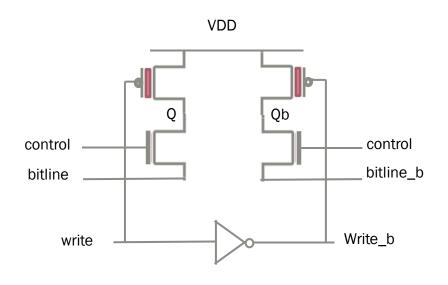


As controlling V_{GS} , we can make FeFET 1/0 by inspecting its I_{D} and correspondent resistance

FeFET as novel-SRAM



Read / Write in This SRAM



Read

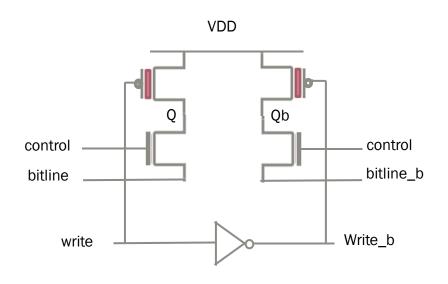
- 1. bitline & blitline_b & control precharge to be "1"
- 2. "0" will pass from Q/Qb
- 3. Turn control & bitline & bitline_b into "0" to regain initial state (gnd depends on the piplining)
- 4. Float ports

Write

- 1. Precharge control to "1" and bitline & bitline_b to be "0"
- 2. Write to the gate of FeFETs to change states
- 3. Turn off ports

**need big width in nmos to make sure data passing

Pros and Cons in This SRAM



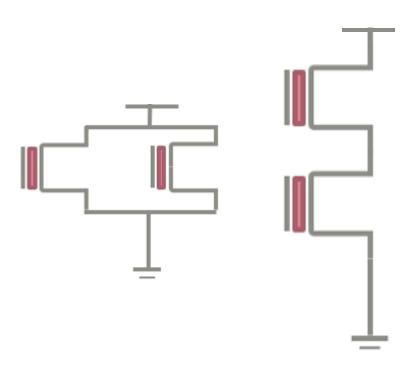
Pros

- 1. Less area and No. of mos
- 2. Less data fluctuation due to FeFET
- 3. Easy Operations
- 4. High potential to circuit extensions
- 5. Good Flexibility

Cons

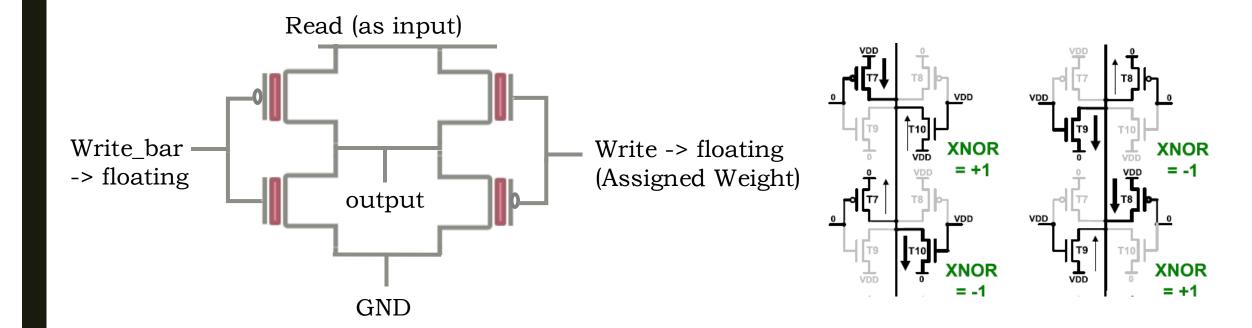
- 1. More ports to satisfy operations
- 2. More complicated datapath and routing

Logics of FeFET



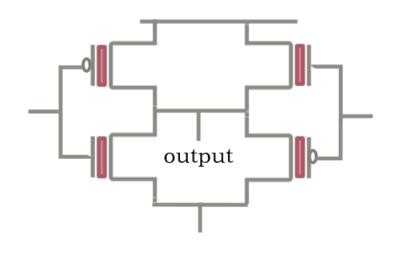
FeFET has the same logic rules as normal MOS, it is beneficial for us to operate following logic circuits of computing

FeFET as XNOR



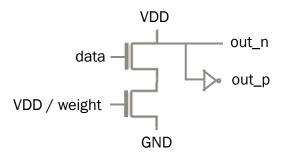
- 1. Exerting the write pulse as weight parameter (1/0) to FeFET and then floating to remove interference and speed up
- 2. While training, the read pulse can be assigned as 1 (1V above) or 0 (1V below) and obtain the calculated results

FeFET into Convolution



gate of p / n	source of p	source of n	data out
0/0	GND	VDD	0
0/1	GND	VDD	0
1/0	VDD	GND	X
1/1	VDD	GND	1

Have advantages to deep pipelines

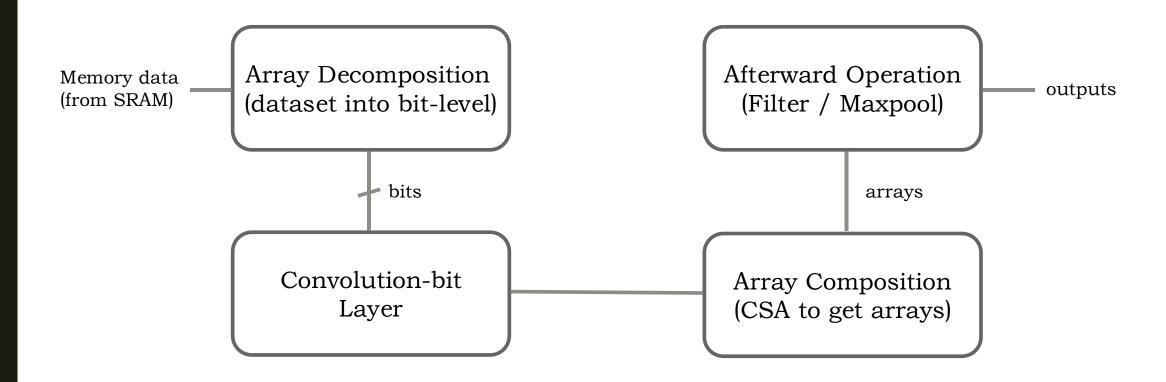


Supply control to FeFET cross pair

Imagine every FeFET to be a single bit. Convolution can be applied into FeFET charging/discharging with additional NAND

** need reset after computing (because of the x of 1/0)

Layer-level Operations of Convolution



Pros and Cons in FeFET Convolution

Pros

- 1. Successfully implement CIM in hardware level
- 2. Speed enhancement by eliminating memory access
- 3. Great tradeoff between area and additional computation
- 4. Weight can be stored in FeFET and be used repeatedly

Cons

- 1. Need another nmos to reset after every convolution (like DRAM)
- 2. Need NAND to have conditional computing
- 3. Stability

Citations

- 1. CMOS-Compatible Fabrication of Low-Power Ferroelectric Tunneling Junction for Neural Network Applications by Yi-Shan Kuo, Shen-Yang Lee, Chia-Chin Lee, Shou-Wei Li, and Tien-Sheng Chao
- 2. SLIM: Simultaneous Logic-in-Memory Computing Exploiting Bilayer Analog OxRAM Devices by Sandeep Kaur Kingra, Vivek Parmar, Che-Chia Chang, Boris Hudec, Tuo-Hung Hou, and Manan Suri
- 3. FeFET details supports by Yi-Shan Kuo
- 4. DIC course instructed by S. J. Jou
- 5. All other reference papers in https://reurl.cc/o99aKl

Thanks for Your Attention:)